

SEMICONDUCTOR®

November 2013

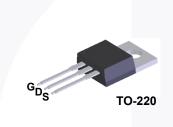
FQP65N06 N-Channel QFET[®] MOSFET 60 V, 65 A, 16 mΩ

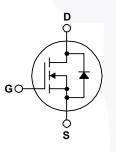
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 65 A, 60 V, $R_{DS(on)}$ = 16 m Ω (Max.) @ V_{GS} = 10 V, I_D = 32.5 A
- Low Gate Charge (Typ. 48 nC)
- Low Crss (Typ. 100 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





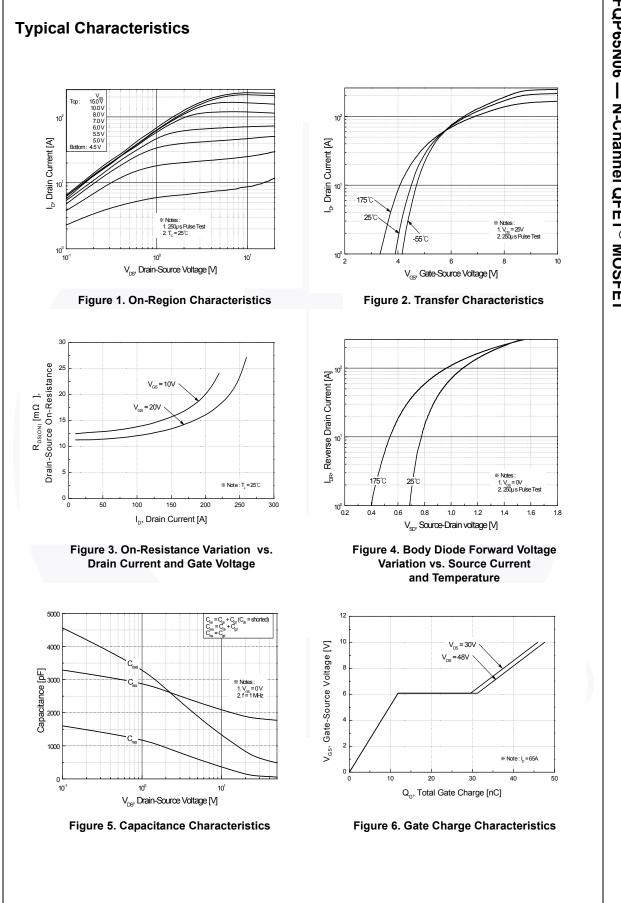
Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

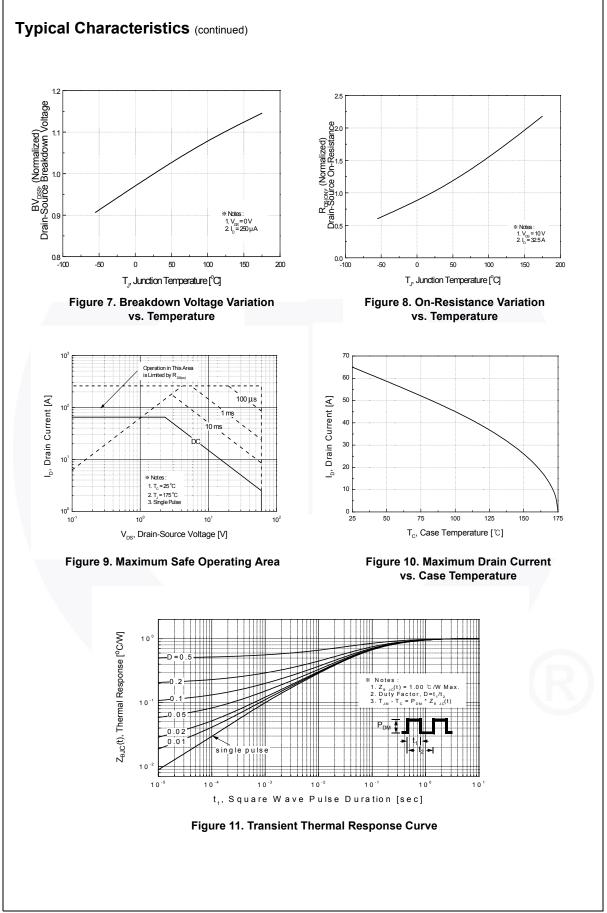
Symbol	Parameter		FQP65N06	Unit
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous (T _C = 25°	C)	65	A
	- Continuous (T _C = 100)°C)	46.1	A
I _{DM}	Drain Current - Pulsed	(Note 1)	260	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	650	mJ
I _{AR}	Avalanche Current	(Note 1) 65		A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	15.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
PD	Power Dissipation (T _C = 25°C)		150	W
	- Derate above 25°C		1.00	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
ΤL	Maximum Lead Temperature for Solderir 1/8" from Case for 5 seconds	ng,	300	°C

Thermal Characteristics

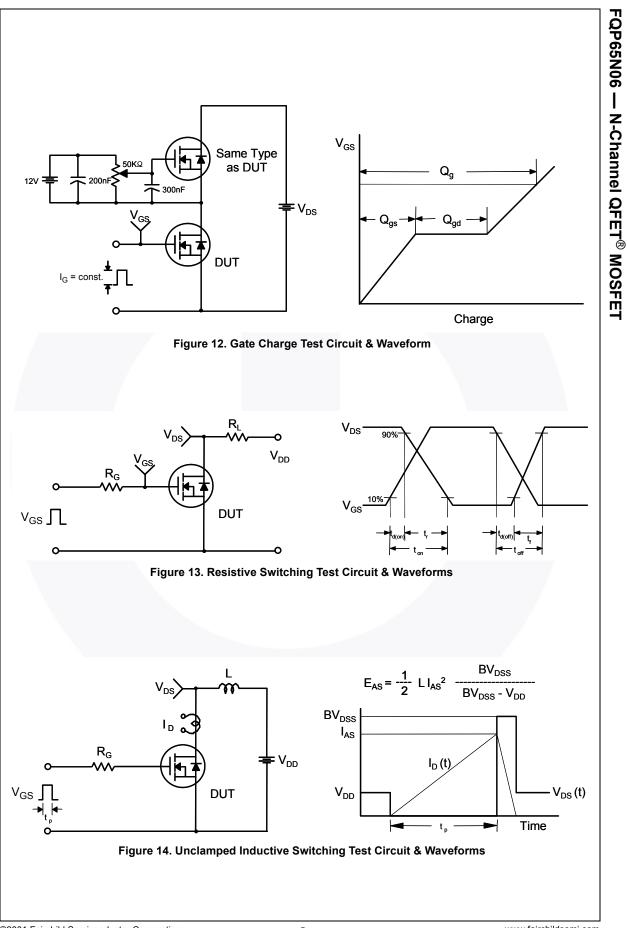
Symbol	Parameter	FQP65N06	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.00	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

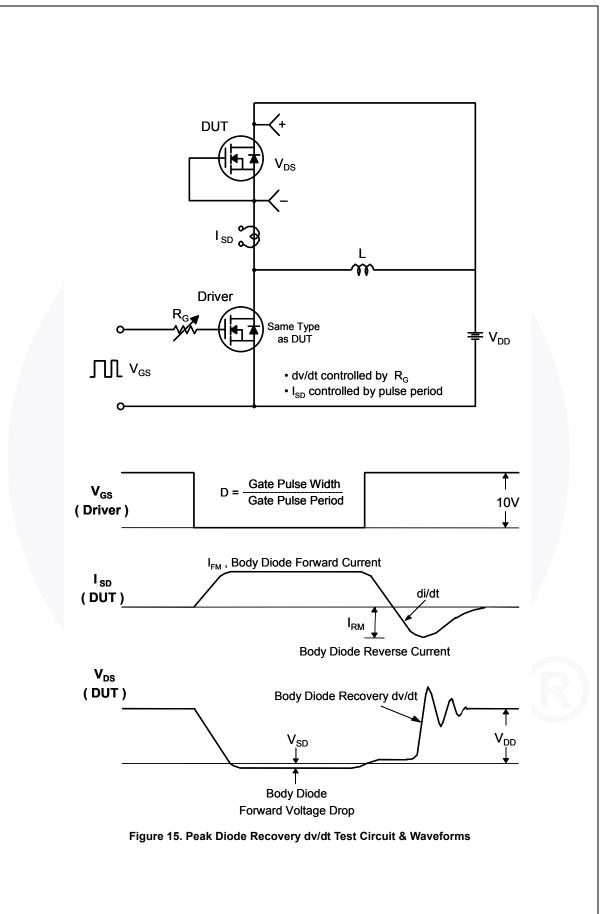
Part NumberTop MarkPackageFQP65N06FQP65N06TO-220		Package	e Packing Method Re		Size	Tape Width		h Q	Quantity	
		Tube N/A		/A	N/A		5	50 units		
lectri	cal C	naracteristics	T _C = 25°C	unless otherwise noted.						
Symbol		Parameter		Test Cond	itions		Min	Тур	Max	Unit
Off Cha	aracte	istics								
V _{DSS}	1	Source Breakdown V	oltage	V _{GS} = 0 V, I _D = 250) uA		60			V
BV _{DSS} ΔT _J		down Voltage Temper	U	$I_D = 250 \ \mu\text{A}, \text{Reference}$		25°C		0.07		V/°C
DSS				V _{DS} = 60 V, V _{GS} =	0 V				1	μA
	Zero G	Sate Voltage Drain Cu	urrent	$V_{DS} = 48 \text{ V}, \text{ T}_{C} = 18$	50°C				10	μA
GSSF	Gate-E	Body Leakage Currer	t, Forward	V _{GS} = 25 V, V _{DS} =	0 V	1			100	nA
SSSR		Body Leakage Currer		V_{GS} = -25 V, V_{DS} =					-100	nA
On Cha	aracter	istics								
GS(th)	Gate 1	hreshold Voltage		$V_{DS} = V_{GS}, I_D = 25$	0 μΑ		2.0		4.0	V
RDS(on)		Drain-Source sistance		V_{GS} = 10 V, I _D = 32.5	5A			0.012	0.016	Ω
FS	Forwa	rd Transconductance		V _{DS} = 25 V, I _D = 32	2.5 A			48		S
viss voss	Input (racteristics Capacitance t Capacitance		V _{DS} = 25 V, V _{GS} = 1 f = 1.0 MHz	0 V,			1850 700	2410 910	pF pF
rss		se Transfer Capacita	nce	1 1.0 10112				100	130	pF
Switch	· · ·	aracteristics							1	
l(on)		n Delay Time		V _{DD} = 30 V, I _D = 32	2.5 A,			20	50	ns
		In Rise Time		R _G = 25 Ω				160	330	ns
l(off)	Turn-C	off Delay Time						90	190	ns
	Turn-C	off Fall Time			(N	lote 4)		105	220	ns
) ^g	Total C	Bate Charge		V _{DS} = 48 V, I _D = 65	5 A,			48	65	nC
) _{gs}	Gate-S	Source Charge		V _{GS} = 10 V				12		nC
l _{gd}	Gate-I	Drain Charge			(N	lote 4)		19.5		nC
)rain-S	Source	Diode Characte	eristics an	d Maximum Ra	tinas					
3		um Continuous Drair			U				65	А
SM	Maxim	um Pulsed Drain-So	urce Diode Fo	orward Current					260	А
SD		Source Diode Forwar	1	$V_{GS} = 0 V, I_{S} = 65 A$	A				1.5	V
r		se Recovery Time		$V_{GS} = 0 V, I_S = 65 A,$				62		ns
l Prr		se Recovery Charge		$dI_{\rm F} / dt = 100 {\rm A}/{\mu s}$				110		nC
		in the second seco								

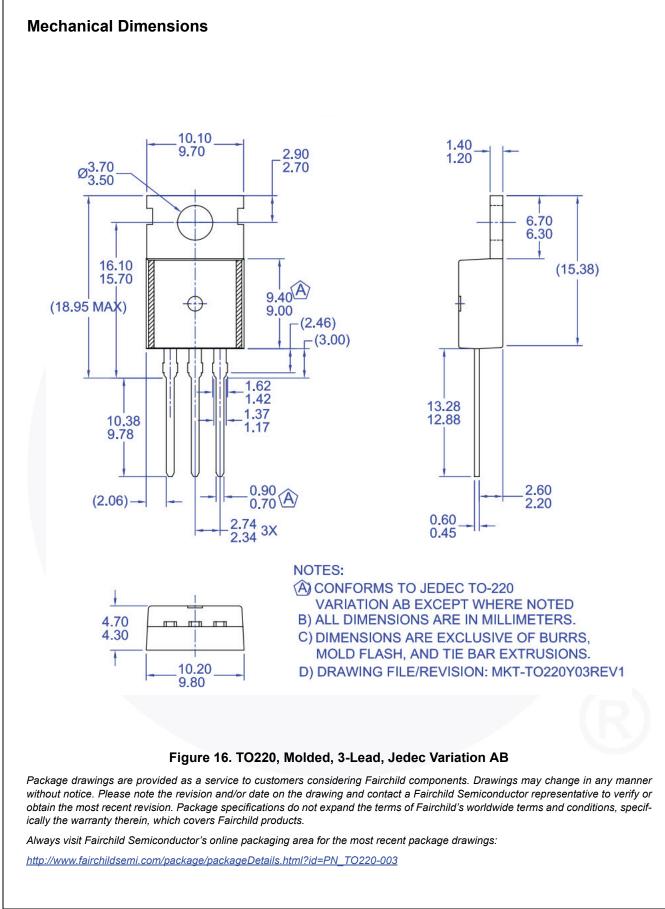




FQP65N06 — N-Channel QFET[®] MOSFET









SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™	
AX-CAP [®] *	FRFET®	
BitSiC™	Global Power Resource SM	PowerTrench [®]
Build it Now™	GreenBridge™	PowerXS™
CorePLUS™	Green FPS™	Programmable Active Droop™
CorePOWER™	Green FPS™ e-Series™	QFET®
CROSSVOLT™	Gmax™	QS™
CTL™	GTO™	Quiet Series™
Current Transfer Logic™	IntelliMAX™	RapidConfigure™
	ISOPLANAR™	TM TM
Dual Cool™	Marking Small Speakers Sound Louder	
EcoSPARK [®]	and Better™	Saving our world, 1mW/W/kW at a time™
EfficentMax™	MegaBuck™	SignalWise™
ESBC™	MICROCOUPLER™	SmartMax™
r R	MicroFET™	SMART START™
+ °	MicroPak™	Solutions for Your Success™
Fairchild [®]	MicroPak2™	SPM [®]
Fairchild Semiconductor®	MillerDrive™	STEALTH™
FACT Quiet Series™	MotionMax™	SuperFET®
FACT®	mWSaver®	SuperSOT™-3
FAST®	OptoHiT™	SuperSOT™-6
FastvCore™	OPTOLOGIC®	SuperSOT™-8
FETBench™	OPTOPLANAR [®]	SupreMOS®
FPS™		SyncFET™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Sync-Lock™ SYSTEM^{®*} GENERAL

TinyBoost

TinyBuck®

TinyCalc™ TinvLogic®

TINYOPTO™

TinvPower™ TinyPWM™ TinyWire™

TranSiC™ TriFault Detect™

µSerDes™

UHC® Ultra FRFET™

XS™

UniFFT™ VCX™

VisualMax™

VoltagePlus™

TRUECURRENT®*

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

FQP65N06 — N-Channel QFET[®] MOSFE

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: